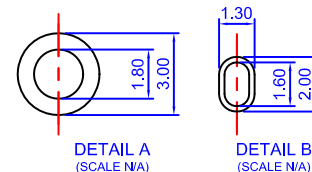
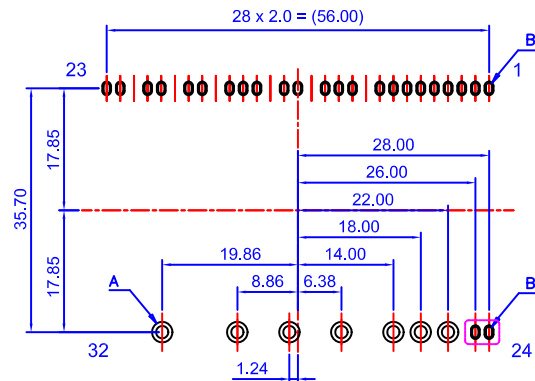
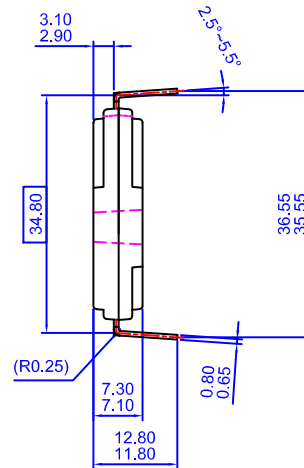
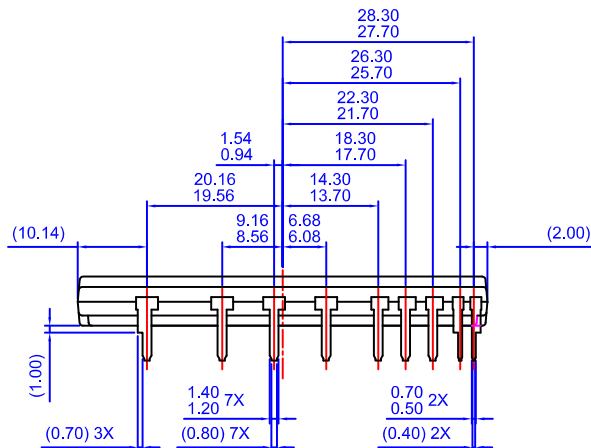
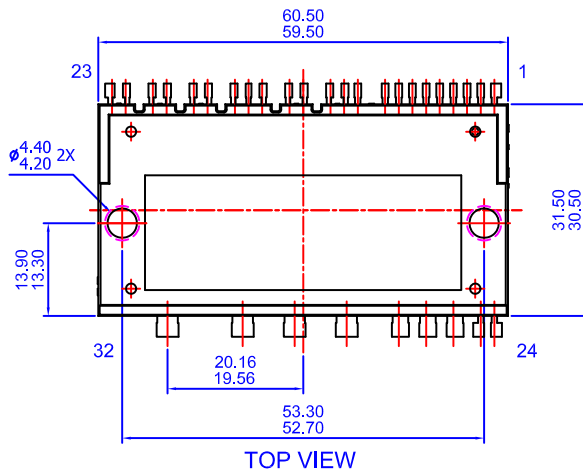
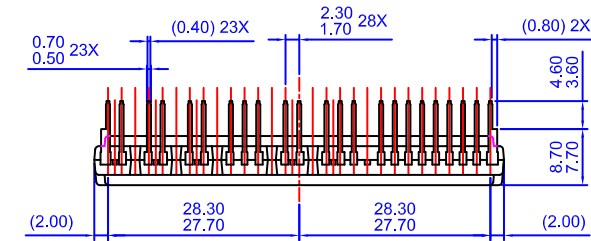


S32CA-032 / 32LD, PDD STD, DBC, DIP TYPE (DBC AIN)
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DATE 31 JAN 2017



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 - B) ALL DIMENSIONS ARE IN MILLIMETERS
 - C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
 - D) () IS REFERENCE

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